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SN74ABT651DBR

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Datasheet of SN74ABT651DBR - IC BUS TRANSCEIVER DUAL 24SSOP

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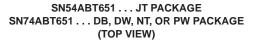
#### SN54ABT651, SN74ABT651 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

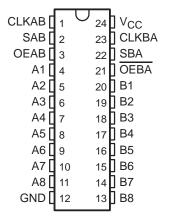
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- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- High-Drive Outputs (-32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- Multiplexed Real-Time and Stored Data
- Inverting Data Paths
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), and Plastic (NT) and Ceramic (JT) DIPs

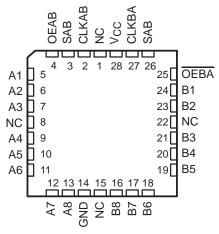
#### description

These devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. Output-enable (OEAB and OEBA) inputs are provided to control the transceiver functions. The select-control (SAB and SBA) inputs are provided to select whether real-time or stored data is transferred. A low input level selects real-time data, and a high input level selects stored data. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'ABT651 devices.





SN54ABT651 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

Data on the A or B bus, or both, can be stored in the internal D flip-flops by low-to-high transitions at the appropriate clock (CLKAB or CLKBA) inputs, regardless of the select- or enable-control pins. When SAB and SBA are in the real-time transfer mode, it also is possible to store data without using the internal D-type flip-flops by simultaneously enabling OEAB and  $\overline{\text{OEBA}}$ . In this configuration, each output reinforces its input. When all the other data sources to the two sets of bus lines are at high impedance, each set remains at its last state.

To ensure the high-impedance state during power up or power down,  $\overline{\text{OEBA}}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver (B to A). OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver (A to B).



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#### description (continued)

The SN54ABT651 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74ABT651 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

#### **FUNCTION TABLE**

		INPU <sup>-</sup>	rs			DAT	A I/O	OPERATION OR FUNCTION
OEAB	OEBA	CLKAB	CLKBA	SAB	SBA	A1-A8	B1-B8	OPERATION OR FUNCTION
L	Н	H or L	H or L	Х	Х	Input	Input	Isolation
L	Н	$\uparrow$	$\uparrow$	X	X	Input	Input	Store A and B data
Х	Н	<b>↑</b>	H or L	Х	Х	Input	Unspecified <sup>†</sup>	Store A, hold B
Н	Н	$\uparrow$	$\uparrow$	X‡	X	Input	Output	Store A in both registers
L	Х	H or L	1	Х	Х	Unspecified <sup>†</sup>	Input	Hold A, store B
L	L	<b>↑</b>	1	Χ	X‡	Output	Input	Store B in both registers
L	L	Χ	Χ	Х	L	Output	Input	Real-time B data to A bus
L	L	Χ	H or L	X	Н	Output	Input	Stored B data to A bus
Н	Н	Х	Х	L	Х	Input	Output	Real-time A data to B bus
Н	Н	H or L	Χ	Н	X	Input	Output	Stored $\overline{A}$ data to B bus
Н	L	H or L	H or L	Н	Н	Output	Output	Stored A data to B bus and stored B data to A bus

<sup>†</sup> The data output functions may be enabled or disabled by a variety of level combinations at OEAB or OEBA. Data input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

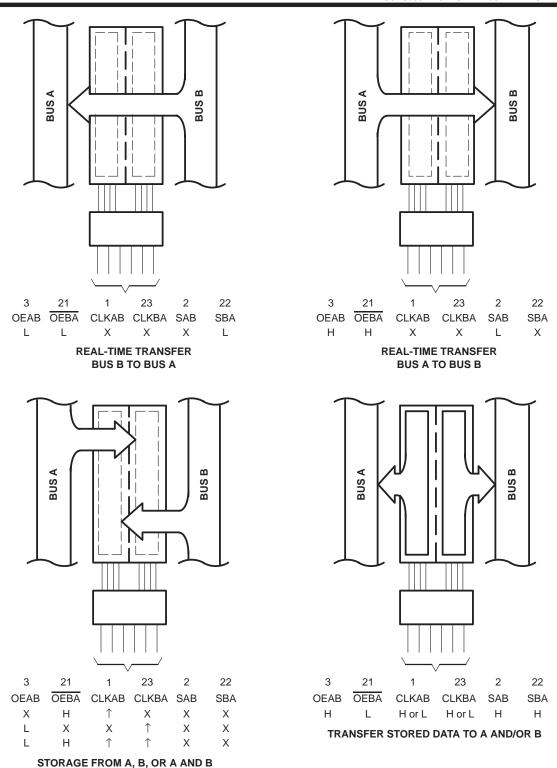


<sup>&</sup>lt;sup>‡</sup> When select control is low, clocks can occur simultaneously if allowances are made for propagation delays from A to B (B to A) plus setup and hold times. When select control is high, clocks must be staggered to load both registers.

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Pin numbers are for the DB, DW, JT, NT, and PW packages.

Figure 1. Bus-Management Functions

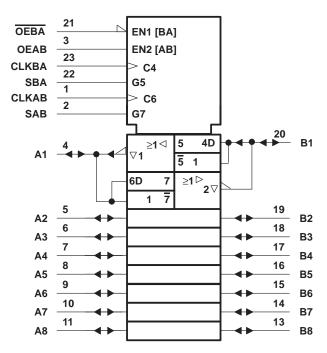




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#### logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DB, DW, JT, NT, and PW packages.

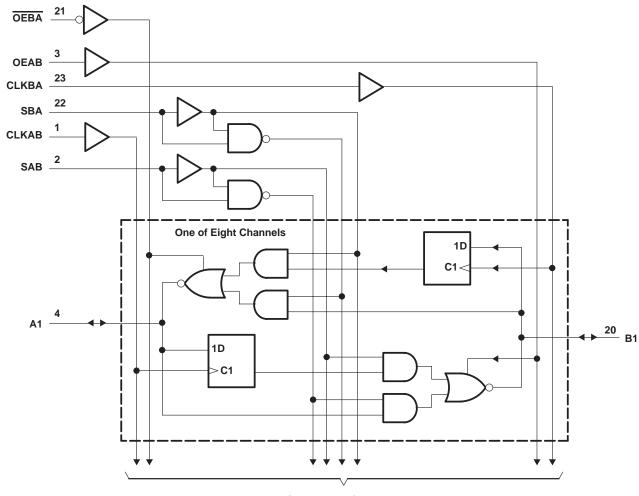


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#### logic diagram (positive logic)



To Seven Other Channels

Pin numbers shown are for the DB, DW, JT, NT, and PW packages.





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	
Voltage range applied to any output in the high or power-off state	
Current into any output in the low state, Io: SN54ABT651	
SN74ABT651	128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–18 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DB package	104°C/W
DW package	81°C/W
NT package	67°C/W
PW package	120°C/W
Storage temperature range, T <sub>stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions (see Note 3)

		SN54ABT6		SN74A	SN74ABT651	
		MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	EM	2		V
VIL	Low-level input voltage		0.8		0.8	V
٧ <sub>I</sub>	Input voltage	0 <	Vcc	0	VCC	V
loh	High-level output current	\\ \( \)	-24		-32	mA
loL	Low-level output current	200	48		64	mA
Δt/Δν	Input transition rise or fall rate	J.	5		5	ns/V
TA	Operating free-air temperature	<b>–</b> 55	125	-40	85	°C

NOTE 3: All unused pins (control or I/O) of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

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#### SN54ABT651, SN74ABT651 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEST CO	Т	A = 25°C	;	SN54A	BT651	SN74A	BT651	UNIT		
PAR	AWEIER	lesi coi	NDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	MAX	MIN	MAX	UNII	
VIK		$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA			-1.2		-1.2		-1.2	V	
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5			
\/a		V <sub>CC</sub> = 5 V,	I <sub>OH</sub> = -3 mA	3			3		3		V	
VOH		V <sub>CC</sub> = 4.5 V	$I_{OH} = -24 \text{ mA}$	2			2				V	
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2			
VOL	V <sub>OI</sub> V <sub>CC</sub> = 4.5 V		I <sub>OL</sub> = 48 mA			0.55		0.55			V	
VOL		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$			0.55*				0.55	V	
V <sub>hys</sub>					100			4			mV	
١,.	Control inputs	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = V <sub>CC</sub> or GND			±1		⊈1		±1	μΑ	
11	A or B ports	VCC = 3.5 V,	AI = ACC 01 QIAD			±100		±100		±100	μΛ	
I <sub>OZH</sub> ‡		$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.7 \text{ V}$			50		50		50	μΑ	
lozL <sup>‡</sup>		$V_{CC} = 5.5 \text{ V},$	$V_0 = 0.5 V$			-50	S	-50		-50	μΑ	
l <sub>off</sub>		$V_{CC} = 0$ ,	$V_I$ or $V_O \le 4.5 \text{ V}$			±100	0			±100	μΑ	
ICEX		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high			50	y <sub>Q</sub>	50		50	μΑ	
I <sub>O</sub> §		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA	
		V <sub>CC</sub> = 5.5 V,	Outputs high			250		250		250	μΑ	
Icc		$I_0 = 0$ ,	Outputs low			30		30		30	mA	
	V <sub>I</sub> = V <sub>CC</sub> or GND Outputs disabled			250		250		250	μΑ			
ΔICC¶		$V_{CC} = 5.5 \text{ V}$ , One inpotential of the original or				1.5		1.5		1.5	mA	
Ci	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V			6						pF	
C <sub>io</sub>	A or B ports	$V_0 = 2.5 \text{ V or } 0.5 \text{ V}$			7.5						pF	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

## timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

		V <sub>CC</sub> :	= 5 V, 25°C	SN54A	BT651	SN74ABT651		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency		125		125		125	MHz
t <sub>W</sub>	Pulse duration, CLK high or low	4		40	25.4	4		ns
t <sub>su</sub>	Setup time, A or B before CLKAB↑ or CLKBA↑	3		234	7/1	3		ns
t <sub>h</sub>	Hold time, A or B after CLKAB↑ or CLKBA↑	0		0		0		ns



<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ .

<sup>&</sup>lt;sup>‡</sup> The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

<sup>§</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

<sup>¶</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			SN54ABT651		SN74ABT651		UNIT
	(INFOT)	(001F01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			125			125		125		MHz
<sup>t</sup> PLH	CLKBA or CLKAB	A or B	2.2	4	5.1	2.2	5.9	2.2	5.6	ns
<sup>t</sup> PHL	CLNBA OF CLNAB	AOIB	1.7	4	5.1	1.7	5.9	1.7	5.6	115
<sup>t</sup> PLH	A or B	B or A	1.5	4	5.1	1.5	6.4	1.5	6.2	ns
<sup>t</sup> PHL	AUIB	BULK	1.5	3.3	4.6	1.5	5.6	1.5	5.4	115
<sup>t</sup> PLH	SAB or SBA <sup>†</sup>	A or B	1.5	4	5.1	1.5	6.8	1.5	6.5	ns
<sup>t</sup> PHL	SAR OL SRAT	AOIB	1.5	3.6	4.9	1.5	6.2	1.5	5.9	
<sup>t</sup> PZH	<del></del> OEBA	А	1.3	3.6	4.6	1.3	5.9	1.3	5.8	ns
t <sub>PZL</sub>	OEBA	A	2.5	5.7	6.8	2.5	8.9	2.5	8.5	
<sup>t</sup> PHZ	OFD.	А	1.5	3.2	4.5	9.5	6.2	1.5	5	20
t <sub>PLZ</sub>	OEBA	A	1.5	3	3.8	1.5	4.3	1.5	4.1	ns
<sup>t</sup> PZH	OEAB	В	1.8	4.3	6.1	1.8	6.7	1.8	6.5	nc
t <sub>PZL</sub>	OEAD	ان	2.9	5.5	6.5	2.9	7.6	2.9	7.4	ns
<sup>t</sup> PHZ	OEAB	В	1.5	3.3	4.5	1.5	6.5	1.5	5.5	nc
t <sub>PLZ</sub>	OEAD	ט	1.5	3.4	4.4	1.5	5.2	1.5	5.1	ns

<sup>†</sup> These parameters are measured with the internal output state of the storage register opposite that of the bus input.

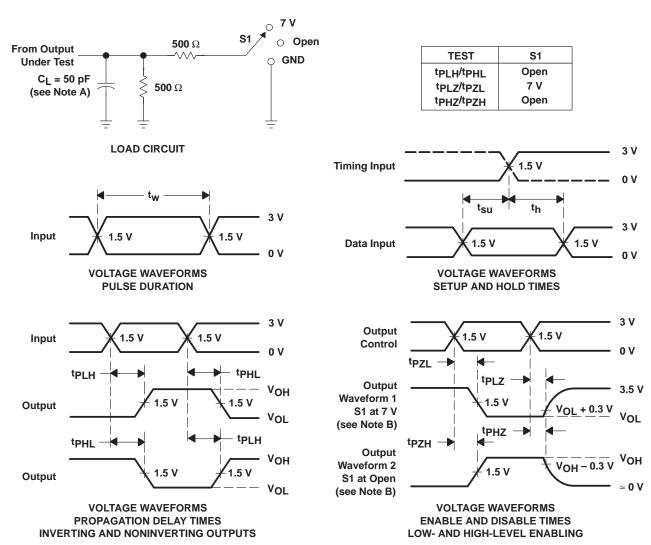


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#### PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5$  ns,  $t_f \leq 2.5$  ns.
  - D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms





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#### PACKAGE OPTION ADDENDUM

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#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74ABT651DBLE	OBSOLETE	SSOP	DB	24		TBD	Call TI	Call TI
SN74ABT651DBR	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DBRE4	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DBRG4	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DWR	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DWRE4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651DWRG4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT651NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ABT651NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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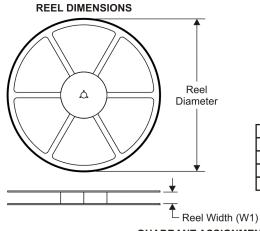
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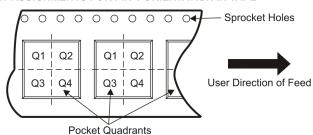
#### TAPE AND REEL INFORMATION



# TAPE DIMENSIONS + K0 + P1 + B0 W Cavity - A0 +

	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

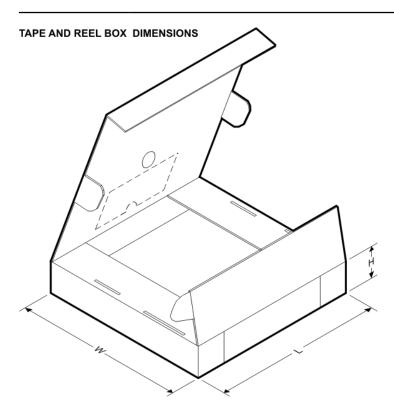
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT651DBR	SSOP	DB	24	2000	330.0	16.4	8.2	8.8	2.5	12.0	16.0	Q1
SN74ABT651DWR	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT651DBR	SSOP	DB	24	2000	346.0	346.0	33.0
SN74ABT651DWR	SOIC	DW	24	2000	346.0	346.0	41.0



## **Distributor of Texas Instruments: Excellent Integrated System Limited**Datasheet of SN74ABT651DBR - IC BUS TRANSCEIVER DUAL 24SSOP

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